

HSF RoHS

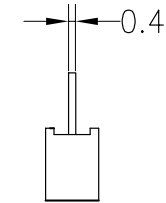
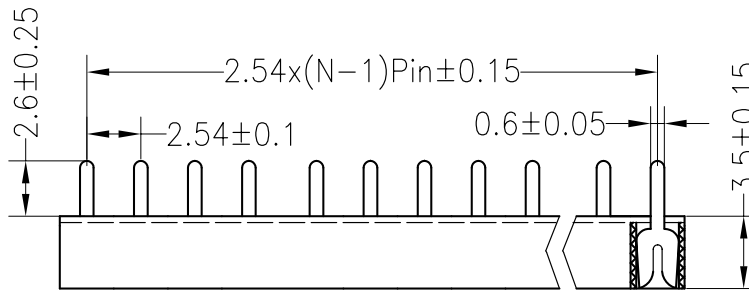
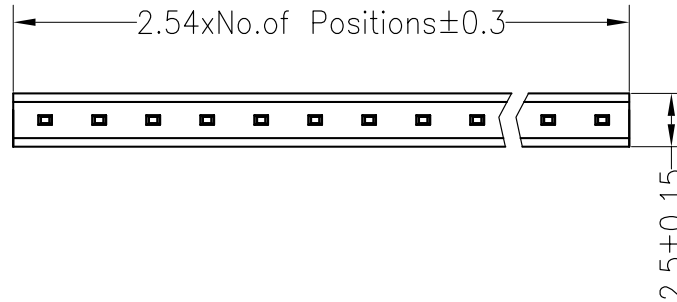
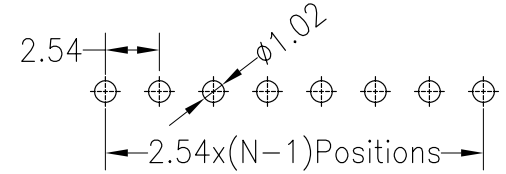


SPECIFICATIONS

Rated Current:3.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°c to +105°c

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PBT
 Max.Processing Temp: 180°C for 30-60 seconds
 (200°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information


PS1S35-1XX X N XX S Y X 01

No.of Pins Per Row 1*40

Insulator Material Option
 A=BK-PBT
 B=BK-PA66
 C=BK-PA6T
 D=BK-PA46
 F=BK-LCP

Contact Plating
 G1:1U" Gold
 G2:1.5U" Gold
 G3:2U" Gold
 G4:3U" Gold
 G5:5U" Gold
 S0:Gold Flash/Tin
 SN:Tin

Packing
 O=PE Bag
 A=Tray
 T=Tube
 P=Tube+Cap
 R=Reel+Cap
 M=Reel+Mylar

				OPERATION		DRAW	YiYuSheng	12.03.28	SCALE	FIT	 <p>professionisti dell'elettronica</p>	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK	SIZE	A4				
				X.XXX	±0.10	APPROVE	SHEET	1/1				
				Angle	±3°		PROJ.	◆				
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL			PART NO.		PS1S35-1XXXNXXSYX01		
								TITLE:		2.54PF H3.5mm 1xNpin 180° DIP		